

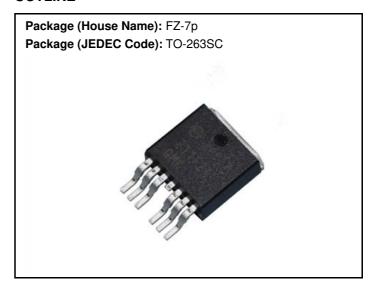
## P170FZ6QNKA

# Power MOSFETs 60V, 170A, N-channel

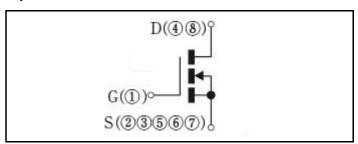
## **Feature**

- N-channel
- SMD
- Super Large Current
- Low Ron
- 10V Gate Drive
- Low Capacitance
- Based on AEC-Q101
- · Halogen free
- Pb free terminal
- RoHS:Yes

## **OUTLINE**



## **Equivalent circuit**



## Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 175	°C
Channel tempertature	Tch		-55 to 175	°C
Drain-source voltage	$V_{DSS}$		60	V
Gate-source voltage	V <sub>GSS</sub>		±20	V
Continuous drain current(DC)	I <sub>D</sub>		170	Α
Continuous drain current(Peak)	I <sub>DP</sub>	Pulse width 10μs, Duty=1/100	510	Α
Continuous source current(DC)	Is		170	Α
Total power dissipation	P <sub>T</sub>	With heatsink	178	W
Total power dissipation	P <sub>T</sub>	Measured on the 1 inch² glass epoxy substrate pattern area: 636.36mm²	3.7	W
Total power dissipation	P <sub>T</sub>	Measured on the 1 inch <sup>2</sup> glass epoxy substrate pattern area: 170.51mm <sup>2</sup>	3	W
Single avalanche current	I <sub>AS</sub>	Starting Tch=25°C Tch≦150°C	64	Α
Single avalanche energy	E <sub>AS</sub>	Starting Tch=25°C Tch≦150°C	204	mJ

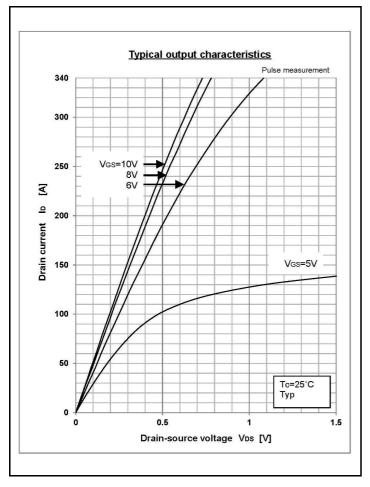
<sup>\* :</sup>See the original Specifications

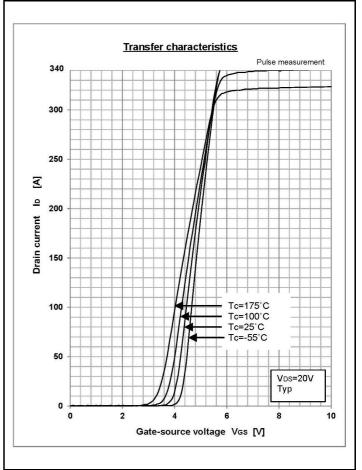
## **Electrical Characteristics** (unless otherwise specified : Tc=25°C)

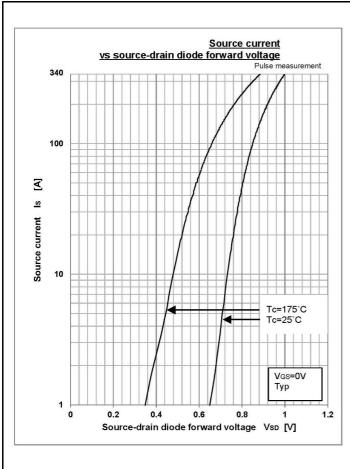
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	Offic
Drain-Source breakdown voltage	V <sub>(BR)DSS</sub>	ID=1mA, VGS=0V	60			V
Zero gate voltage drain current	I <sub>DSS</sub>	VDS=60V, VGS=0V			10	μΑ
Gate-source leakage current	I <sub>GSS</sub>	VGS=±20V, VDS=0V			±0.1	μΑ
Forward transconductance	g <sub>fs</sub>	ID=42.5A, VDS=10V	32			S
Static drain-source on-state resistance	R <sub>DS(ON)</sub>	ID=85A, VGS=10V		0.00193	0.0024	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	2	3	4	V
Source-drain diode forward voltage	$V_{SD}$	IS=85A, VGS=0V			1.2	V
Thermal resistance	Rth(j-c)	Junction to case, With heatsink			0.84	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, Measured on the 1 inch <sup>2</sup> glass epoxy substrate pattern area: 636.36mm <sup>2</sup>			40	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, Measured on the 1 inch glass epoxy substrate pattern area: 170.51mm			50	°C/W
Total gate charge	Qg	VDS=48V, VGS=10V, ID=85A		130		nC
Gate to source charge	Qgs	VDS=48V, VGS=10V, ID=85A		36		nC
Gate to drain charge	Qgd	VDS=48V, VGS=10V, ID=85A		49		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		8090		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		370		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		820		pF
Turn-on delay time	td(on)	ID=42.5A, RL=0.71Ω, VDS=30V, Rg=0Ω, +VGS=10V, -VGS=0V		13		ns
Rise time	tr	ID=42.5A, RL=0.71Ω, VDS=30V, Rg=0Ω, +VGS=10V, -VGS=0V		38		ns
Turn-off delay time	td(off)	ID=42.5A, RL=0.71Ω, VDS=30V, Rg=0Ω, +VGS=10V, -VGS=0V		104		ns
Fall time	tf	ID=42.5A, RL=0.71Ω, VDS=30V, Rg=0Ω, +VGS=10V, -VGS=0V		40		ns
Diode reverse recovery time	trr	IS=85A, VGS=0V, -di/dt=100A/μs		51		ns
Diode reverse recovery charge	Qrr	IS=85A, VGS=0V, -di/dt=100A/μs		85		nC

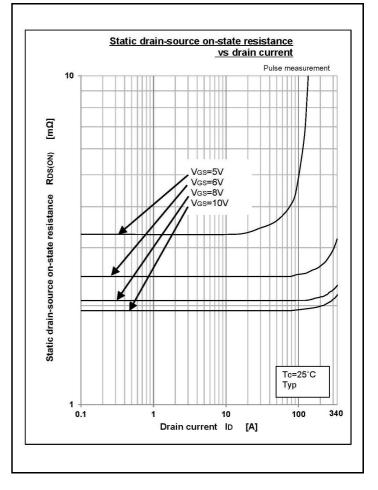
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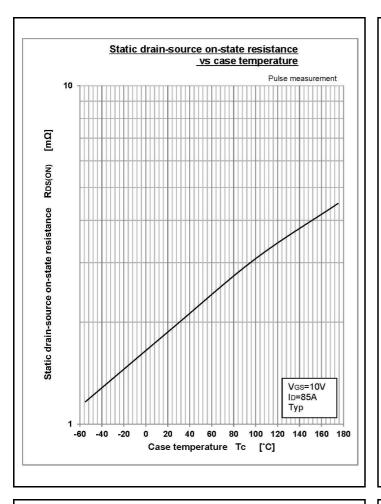
## **CHARACTERISTIC DIAGRAMS**

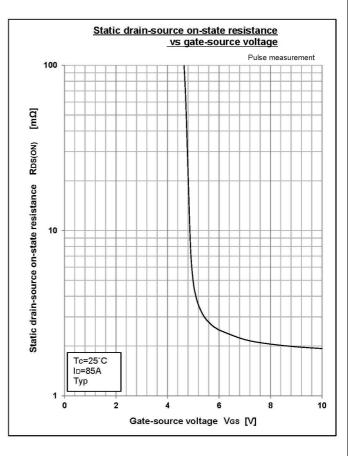


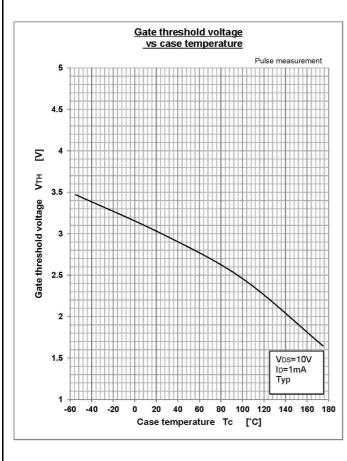


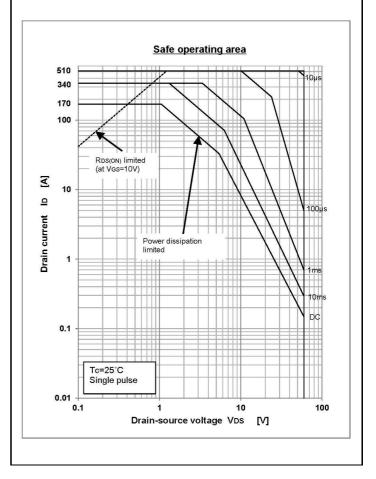


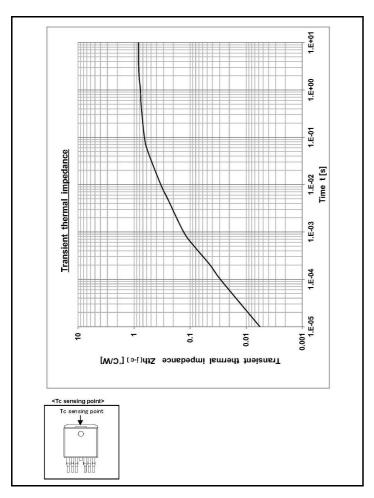


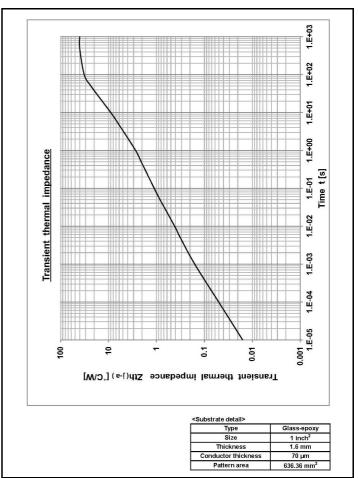


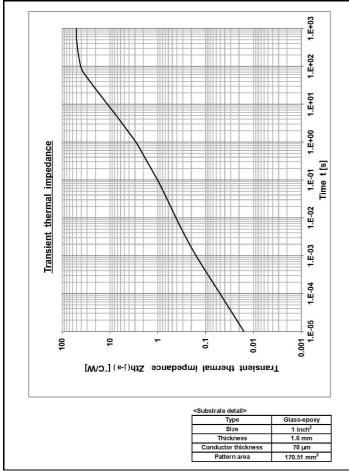


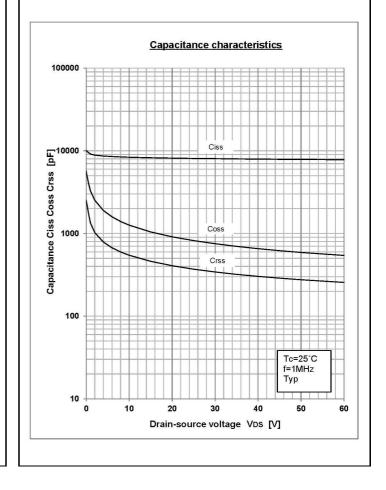


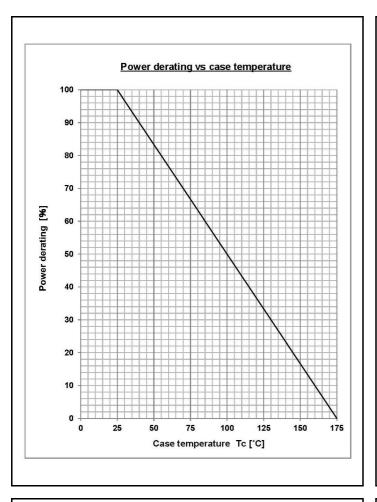


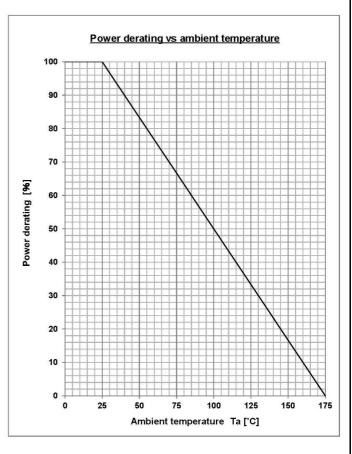


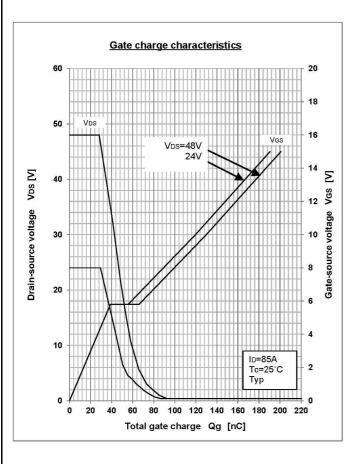


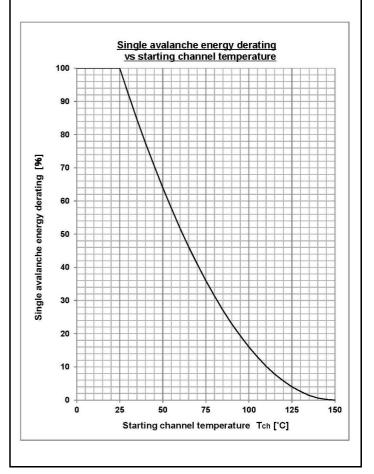








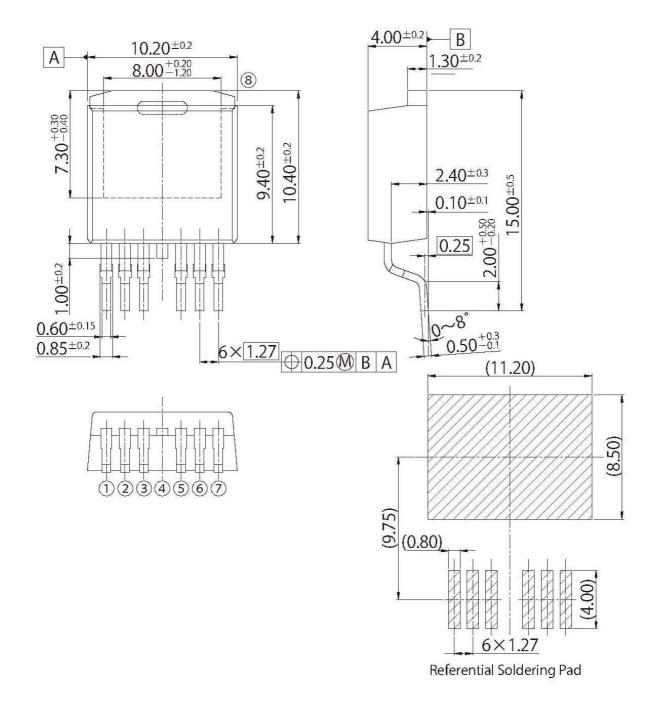




6/8

**H7** 

JEDEC Code	TO-263SC		
JEITA Code	—		
House Name	FZ-7p		



<sup>•</sup> Optimize soldering pad to the board design and soldering condition

#### **Notes**

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